
2SD787, 2SD788

Silicon NPN Epitaxial

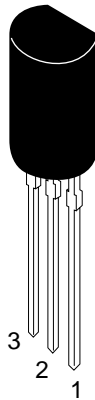
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Application

- Low frequency power amplifier
- Complementary pair with 2SB738 and 2SB739

Outline

TO-92MOD



1. Emitter
2. Collector
3. Base

2SD787, 2SD788

Absolute Maximum Ratings (Ta = 25°C)

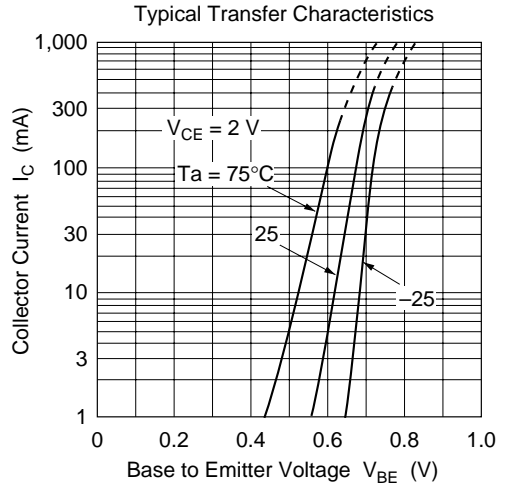
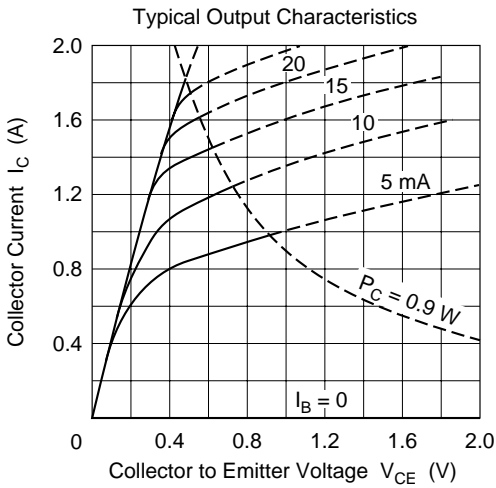
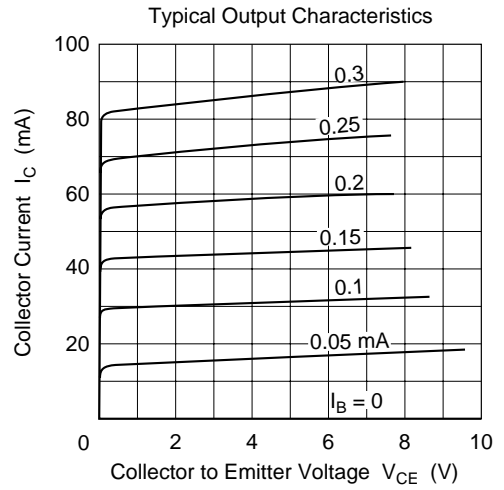
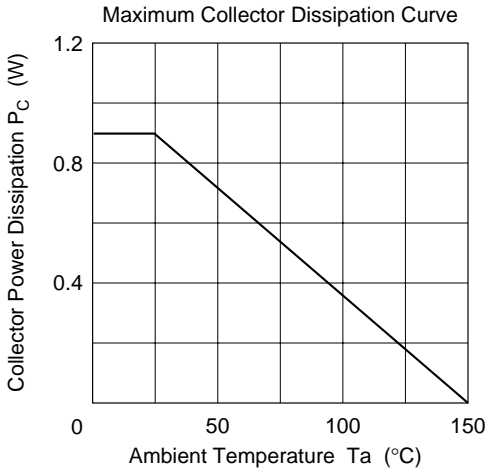
Item	Symbol	2SD787	2SD788	Unit
Collector to base voltage	V_{CBO}	20	20	V
Collector to emitter voltage	V_{CEO}	16	20	V
Emitter to base voltage	V_{EBO}	6	6	V
Collector current	I_C	2	2	A
Collector power dissipation	P_C	0.9	0.9	W
Junction temperature	T_j	150	150	°C
Storage temperature	T_{stg}	-55 to +150	-50 to +150	°C

Electrical Characteristics (Ta = 25°C)

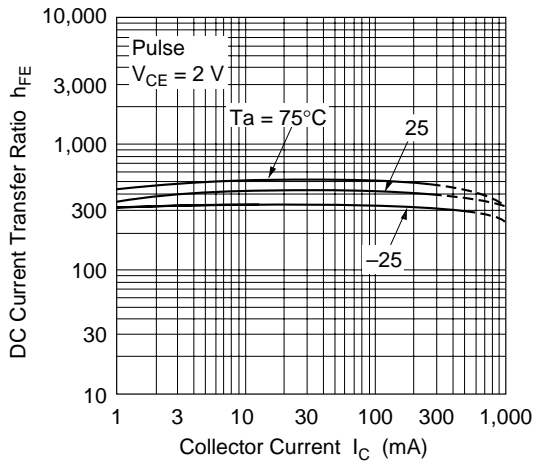
Item	Symbol	2SD787			2SD788			Unit	Test conditions
		Min	Typ	Max	Min	Typ	Max		
Collector to base breakdown voltage	$V_{(BR)CBO}$	20	—	—	20	—	—	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	16	—	—	20	—	—	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	6	—	—	6	—	—	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I_{CBO}	—	—	2	—	—	2	μA	$V_{CB} = 16 \text{ V}, I_E = 0$
Emitter cutoff current	I_{EBO}	—	—	0.2	—	—	0.2	μA	$V_{EB} = 6 \text{ V}, I_C = 0$
DC current transfer ratio	h_{FE}^{*1}	100	—	800	100	—	800		$V_{CE} = 2 \text{ V}, I_C = 0.1 \text{ A}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	0.3	—	—	0.3	V	$I_C = 1 \text{ A}, I_B = 0.1 \text{ A}$
Gain bandwidth product	f_T	—	100	—	—	100	—	MHz	$V_{CE} = 2 \text{ V}, I_C = 10 \text{ mA}$
Collector output capacitance	C_{ob}	—	20	—	—	20	—	pF	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$

Note: 1. The 2SD787 and 2SD788 are grouped by h_{FE} as follows.

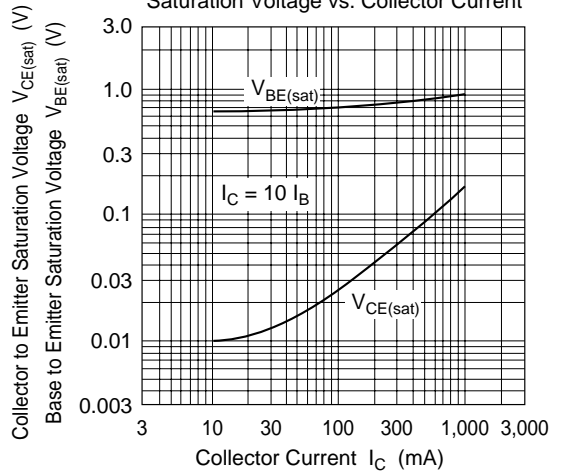
B	C	D	E
100 to 200	160 to 320	250 to 500	400 to 800



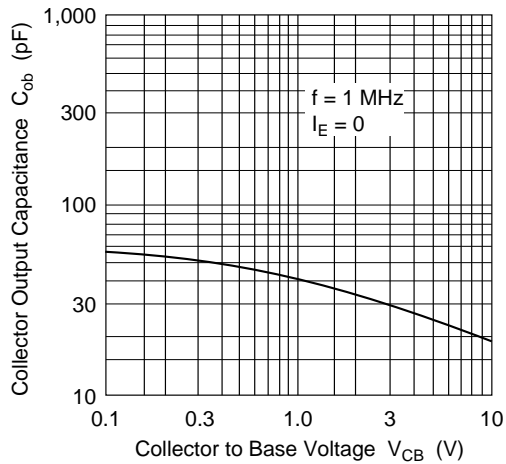
DC Current Transfer Ratio vs. Collector Current

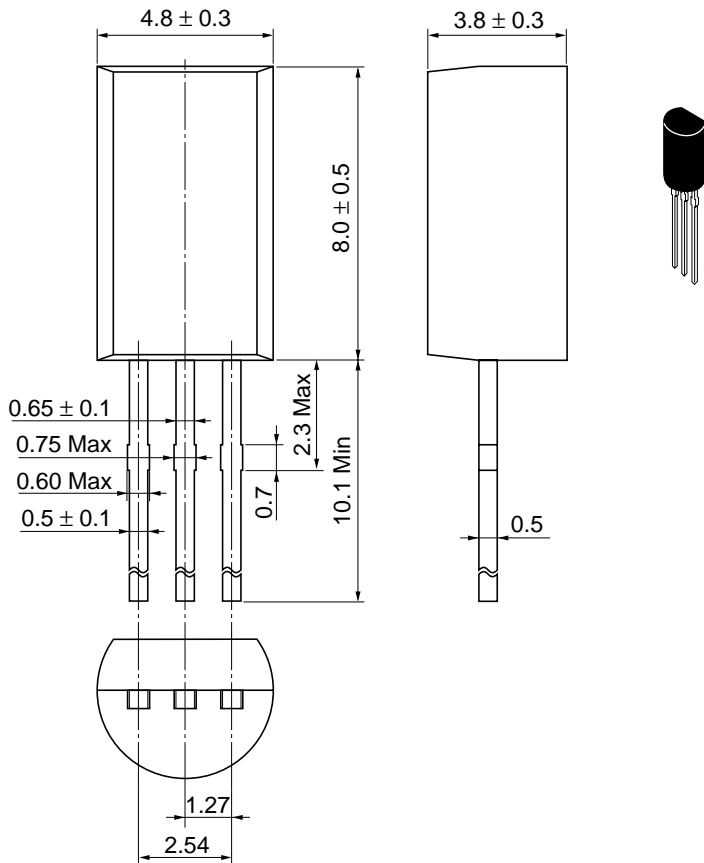


Saturation Voltage vs. Collector Current



Collector Output Capacitance vs. Collector to Base Voltage





Hitachi Code	TO-92 Mod
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.35 g

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